

01-03-2002  
101932623

Docket No.: TSL1693

ET U.S. DEPARTMENT OF COMMERCE  
Patent and Trademark Office

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To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):  
**TAKU KOYAMA**  
**NOBUO KAIYA**

Additional names(s) of conveying party(ies)  Yes  No

3. Nature of conveyance: *MRU 12/18/01*

Assignment  Merger  
 Security Agreement  Change of Name  
 Other \_\_\_\_\_

Execution Date: **December 12 & 13, 2001**

2. Name and address of receiving party(ies):

Name: **Dow Corning Toray Silicone Company, LTD.**

Address: **4th Floor, AIG Building**  
**1-1-3, Marunouchi, Chiyoda-ku,**

City: **Tokyo 100-0005** State/Prov.: \_\_\_\_\_  
Country: **Japan** ZIP: \_\_\_\_\_

Additional name(s) & address(es)  Yes  No

11017 U.S. PTO  
10/024062  
12/16/01

4. Application number(s) or patent numbers(s):

If this document is being filed together with a new application, the execution date of the application is: **December 12, 2001 & December 13, 2001**

Patent Application No.	Filing date	B. Patent No.(s)
<i>10024062</i>		

Additional numbers  Yes  No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: **Patricia M. Scaduto**

Registration No. **39,827**

Address: **Dow Corning Corporation**  
**Intellectual Property Dept. - Mail CO1232**  
**2200 W. Salzburg Rd., P. O. Box 994**

City: **Midland** State/Prov.: **MI**  
Country: **US** ZIP: **48686-0994**

6. Total number of applications and patents involved: **1**

7. Total fee (37 CFR 3.41): .....\$ **40.00**

Enclosed - Any excess or insufficiency should be credited or debited to deposit account  
 Authorized to be charged to deposit account

8. Deposit account number:  
**04-1520**

(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature. *40.00 CH*

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

**Patricia M. Scaduto** *Patricia M. Scaduto* **Dec 18, 2001**  
Name of Person Signing Signature Date

Total number of pages including cover sheet, attachments, and **3**

Mail documents to be recorded with required cover sheet information to:  
Commissioner of Patents & Trademarks, Box Assignments

**PATENT**  
**REEL: 012402 FRAME: 0969**

A S S I G N M E N T

WHEREAS We, Taku Koyama, and Nobuo Kaiya have invented certain new and useful improvements in

SILICONE COMPOSITION FOR FORMING CURED RELEASE COATINGS

for which application for United States Letters Patent has been executed by us on the  
12th day of December, 2001; and, 13th day of December, 2001.

WHEREAS, DOW CORNING TORAY SILICONE COMPANY, LTD., of 4th Floor, AIG Building, 1-1-3, Marunouchi, Chiyoda-ku, Tokyo 100-0005, Japan, is desirous of acquiring the said invention and said application and any and all Letters Patent that may be obtained therefor or thereupon, and all reissues and extensions thereof;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that for and in consideration of the sum of 250 Yen, and other good and valuable considerations, to us in hand paid by the said DOW CORNING TORAY SILICONE COMPANY, LIMITED, the receipt of which is hereby acknowledged, we have sold, assigned, transferred and set over and by these presents do sell, assign, transfer and set over unto the said DOW CORNING TORAY SILICONE COMPANY, LTD., its successors, and assigns, the full and exclusive right, title and interest in and to said invention and said application for Letters Patent of the United States therefore, and in and to any Divisions and Continuations thereof and in and to any and all United States Letters Patent and reissues and extensions thereof that may be issued for the said invention, to have and to hold for its own use and behoof and the use and behoof of its successors and assigns as fully and entirely as the same might be enjoyed by us if this sale and assignment had not been made; and

HEREBY AUTHORIZE and request the Commissioner of Patents and Trademarks to issue the said Letters Patent and any reissues and extensions thereof to the said DOW CORNING TORAY SILICONE COMPANY, LTD. as assigns of the entire right, title and interest in and to the said invention and said application and Letters Patent issued therefore or thereupon; and

HEREBY AGREE to execute all instruments and documents within our power which may be necessary for the carrying out of this assignment in full; and to execute any divisional or continuing application or applications which may be necessary or proper to obtain full protection on the invention hereby assigned; and to execute any and all supplemental oaths and preliminary statements should the same be proper and necessary in the prosecution of the aforesaid applications; and

HEREBY FURTHER ASSIGN unto the said DOW CORNING TORAY SILICONE COMPANY, LIMITED, its successors, and assigns, the whole right, title and interest in and to the invention disclosed in the said application throughout all countries foreign to the United States, and do hereby ratify any acts of the said DOW CORNING TORAY SILICONE COMPANY, LIMITED, its successors and assigns, in applying for patents therefore in its own name in countries where such procedure is proper and do agree to execute applications for said invention in the several countries where it is necessary that the same be executed by the inventors, and to execute assignments of such applications and the patents to be obtained therefore to the said DOW CORNING TORAY SILICONE COMPANY, LIMITED, its successors and assigns.

IN WITNESS WHEREOF I have hereunto set my hand

Taku Koyama  
Taku Koyama

Dated: December 13, 2001

This is to certify that Taku Koyama has signed this document in my presence this 13<sup>th</sup> day of December, 2001, Japan.

Hikari Haga  
Signature of Witness  
Hikari Haga

IN WITNESS WHEREOF I have hereunto set my hand

Nobuo Kaiya  
Nobuo Kaiya

Dated: December 12, 2001

This is to certify that Nobuo Kaiya has signed this document in my presence this 12<sup>th</sup> day of December, 2001, Japan.

Hikari Haga  
Signature of Witness  
Hikari Haga